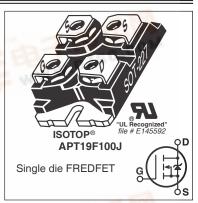


**APT41F100J** 

1000V, 41A, 0.21 $\Omega$  Max,  $t_{rr} \leq$ 400ns

# N-Channel FREDFET

Power MOS  $8^{\text{TM}}$  is a high speed, high voltage N-channel switch-mode power MOSFET. This 'FREDFET' version has a drain-source (body) diode that has been optimized for high reliability in ZVS phase shifted bridge and other circuits through reduced  $t_{rr}$ , soft recovery, and high recovery dv/dt capability. Low gate charge, high gain, and a greatly reduced ratio of  $C_{rss}/C_{iss}$  result in excellent noise immunity and low switching loss. The intrinsic gate resistance and capacitance of the poly-silicon gate structure help control di/dt during switching, resulting in low EMI and reliable paralleling, even when switching at very high frequency.



#### **FEATURES**

- · Fast switching with low EMI
- · Low trr for high reliability
- $\bullet\,$  Ultra low  ${\rm C}_{\rm rss}$  for improved noise immunity
- · Low gate charge
- · Avalanche energy rated
- RoHS compliant

## TYPICAL APPLICATIONS

- · ZVS phase shifted and other full bridge
- Half bridge
- PFC and other boost converter
- Buck converter
- · Single and two switch forward
- Flyback

**Absolute Maximum Ratings** 

Symbol	Parameter	Ratings	Unit
I_	Continuous Drain Current @ T <sub>C</sub> = 25°C	41	
'D	Continuous Drain Current @ T <sub>C</sub> = 100°C	26	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>①</sup>	260	
V <sub>GS</sub>	Gate-Source Voltage	±30	٧
E <sub>AS</sub>	Single Pulse Avalanche Energy®	4075	mJ
I <sub>AR</sub>	Avalanche Current, Repetitive or Non-Repetitive	33	Α

#### **Thermal and Mechanical Characteristics**

Symbol	Characteristic	Min	Тур	Max	Unit	
P <sub>D</sub>	Total Power Dissipation @ T <sub>C</sub> = 25°C			960	W	
$R_{\theta JC}$	Junction to Case Thermal Resistance			0.13	°C/M	
$R_{\theta CS}$	Case to Sink Thermal Resistance, Flat, Greased Surface		0.15		°C/W	
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55		150	°C	
VIsolation	RMS Voltage (50-60hHz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.)	2500			V	
W <sub>T</sub>	Darkers Weight		1.03		OZ	
	Package Weight		29.2		g	
表 PDI	Tamerical and Maunting Cayous		·	10	in∙lbf	
orque				1.1	N·m	

#### **Static Characteristics**

# $T_J = 25^{\circ}C$ unless otherwise specified

**APT41F100J** 

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V <sub>BR(DSS)</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 250\mu A$		1000			V
$\Delta V_{BR(DSS)}/\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I <sub>D</sub> = 250µA			1.15		V/°C
R <sub>DS(on)</sub>	Drain-Source On Resistance <sup>®</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 33A			0.19	0.21	Ω
V <sub>GS(th)</sub>	Gate-Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 5mA$		3	4	5	V
$\Delta V_{GS(th)}/\Delta T_{J}$	Threshold Voltage Temperature Coefficient				-10		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 1000V	$T_J = 25^{\circ}C$			250	μA
		$V_{GS} = 0V$	T <sub>J</sub> = 125°C			1000	μΑ
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = ±30V			·	±100	nA

### **Dynamic Characteristics**

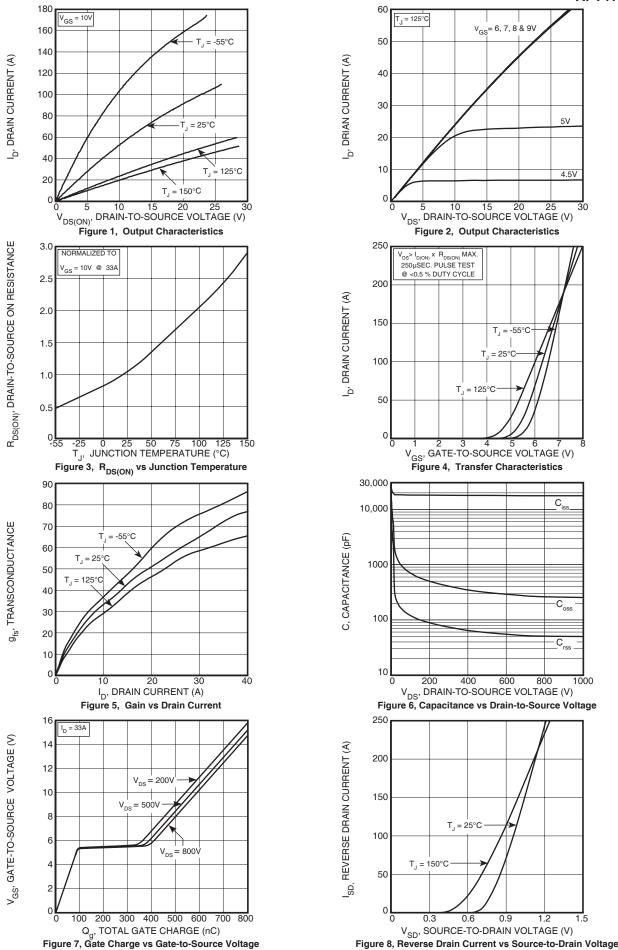
### $T_{.1} = 25^{\circ}C$ unless otherwise specified

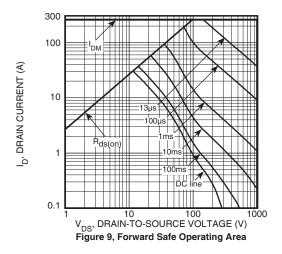
- J = 25 G almost Ghormag								
Symbol	Parameter	Test Conditions Min T		Тур	Max	Unit		
9 <sub>fs</sub>	Forward Transconductance	$V_{DS} = 50V, I_{D} = 33A$		75		S		
C <sub>iss</sub>	Input Capacitance	V 0V V 05V		18500				
C <sub>rss</sub>	Reverse Transfer Capacitance	$V_{GS} = 0V, V_{DS} = 25V$ f = 1MHz		245				
C <sub>oss</sub>	Output Capacitance	1 - 11/11/12		1555				
C <sub>o(cr)</sub> ④	Effective Output Capacitance, Charge Related	V 0V V 0V to 507V		635		pF		
C <sub>o(er)</sub> ⑤	Effective Output Capacitance, Energy Related	$V_{GS} = 0V$ , $V_{DS} = 0V$ to 667V		325				
Q <sub>g</sub>	Total Gate Charge	V 0 t- 40V I 00A		570				
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 0 \text{ to } 10V, I_{D} = 33A,$		100		nC		
Q <sub>gd</sub>	Gate-Drain Charge	$V_{DS} = 500V$		270				
t <sub>d(on)</sub>	Turn-On Delay Time	Resistive Switching		55				
t <sub>r</sub>	Current Rise Time	V <sub>DD</sub> = 667V, I <sub>D</sub> = 33A		55		ne		
t <sub>d(off)</sub>	Turn-Off Delay Time	$R_{G} = 2.2\Omega^{\odot}, V_{GG} = 15V$		235		ns		
t <sub>f</sub>	Current Fall Time			55				

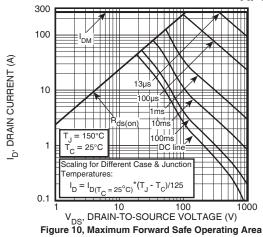
#### **Source-Drain Diode Characteristics**

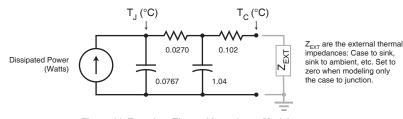
Symbol	Parameter	Test Condi	Min	Тур	Max	Unit	
Is	Continuous Source Current (Body Diode)	MOSFET symbol showing the				41	А
I <sub>SM</sub>	Pulsed Source Current (Body Diode) <sup>①</sup>	integral reverse p-n junction diode (body diode)	G S			260	A
V <sub>SD</sub>	Diode Forward Voltage	$I_{SD} = 33A, T_{J} = 25^{\circ}C, V_{GS} = 0V$				1.0	V
t <sub>rr</sub>	Reverse Recovery Time		T <sub>J</sub> = 25°C			400	no
rr		Γ	T <sub>J</sub> = 125°C			800	ns
0	Reverse Recovery Charge	I <sub>SD</sub> = 33A <sup>③</sup>	T <sub>J</sub> = 25°C		3.3		μС
$Q_{rr}$		V <sub>DD</sub> = 100V	T <sub>J</sub> = 125°C		8.0		
I <sub>rrm</sub>	Reverse Recovery Current	di <sub>SD</sub> /dt = 100A/μs	T <sub>J</sub> = 25°C		17.2		۸
		T <sub>J</sub> = 125°C			24.6		Α
dv/dt	Peak Recovery dv/dt	$I_{SD} \le 33A$ , di/dt $\le 1000A/\mu s$ , $V_{DD} = 667V$ , $T_J = 125^{\circ}C$				25	V/ns

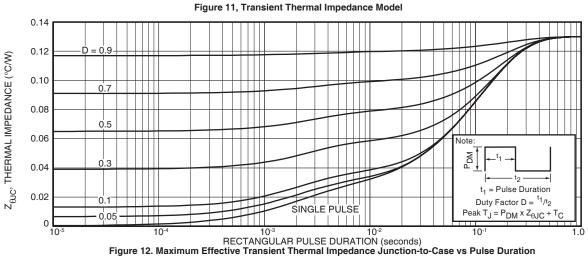
- (1) Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- ② Starting at  $T_1 = 25$ °C, L = 7.48mH,  $R_G = 2.2\Omega$ ,  $I_{AS} = 33$ A.
- (3) Pulse test: Pulse Width < 380µs, duty cycle < 2%.
- $\begin{array}{l} \textcircled{4} \quad \textbf{C}_{o(cr)} \text{ is defined as a fixed capacitance with the same stored charge as } \textbf{C}_{OSS} \text{ with } \textbf{V}_{DS} = 67\% \text{ of } \textbf{V}_{(BR)DSS}. \\ \textcircled{5} \quad \textbf{C}_{o(er)} \text{ is defined as a fixed capacitance with the same stored energy as } \textbf{C}_{OSS} \text{ with } \textbf{V}_{DS} = 67\% \text{ of } \textbf{V}_{(BR)DSS}. \\ \textbf{To calculate } \textbf{C}_{o(er)} \text{ for any value of } \textbf{V}_{DS} \text{ less than } \textbf{V}_{(BR)DSS}, \text{ use this equation: } \textbf{C}_{o(er)} = -5.37\text{E}-7/\text{V}_{DS}^2 + 9.48\text{E}-8/\text{V}_{DS} + 1.83\text{E}-10. \\ \end{array}$
- 6 R<sub>G</sub> is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)











## SOT-227 (ISOTOP®) Package Outline

